INTEGRATED CIRCUITS

DATA SHEET

74LVC1284

3.3V Parallel printer interface transceiver/buffer

Product specification

1995 Nov 10

IC24 Low Voltage Handbook





3.3V Parallel printer interface transceiver/buffer

74LVC1284

FEATURES

- Asynchronous operation
- 4-Bit transceivers
- 3 additional buffer/driver lines
- TTL compatible inputs
- ESD protection exceeds 1000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Input Hysteresis
- Low Noise Operation
- Center Pin V_{CC} & GND
- IEEE 1284 Compliant Level 1 & 2
- Overvoltage Protection on B side

DESCRIPTION

The 74LVC1284 parallel interface chip is designed to provide an asynchronous, 4-bit, bi-directional, parallel printer interface for personal computers. Three additional lines are included to provide handshaking signals between the host and the peripheral. The part is designed to match IEEE 1284 standard.

The 4 transceiver pins (A/B 1-4) allow data transmission from the A bus to the B bus, or from the B bus to the A bus, depending on the state of the direction pin DIR.

The B bus and the Y5-Y7 lines have totem pole or open drain style outputs depending on the state of the high drive enable pin HD. The A bus only has totem pole style outputs. All inputs are TTL compatible with at least 300mV of input hysteresis at $V_{CC} = 3.3V$.

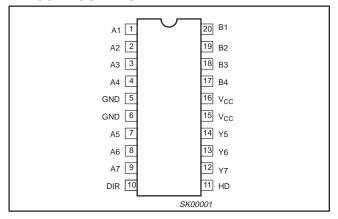
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^{\circ}C; GND = 0V$	TYPICAL	UNIT
R _D	B/Y Side output resistance	$V_{CC} = 3.3V; V_O = 1.65V \pm 0.2V$ (See Figure 2)	45	Ω
SR	B/Y Side slew rate	$R_L = 62\Omega$; $C_L = 50pF$ (See Waveform 4)	0.2	V/ns
Icc	Total static current	$V_I = V_{CC}/GND; I_O = 0$	5	μΑ
V _{HYS}	Input hysteresis	V _{CC} = 3.3V	0.4	V
t _{PLH} /t _{PHL} A –B/Y	Propagation delay to the B/Y side outputs	V _{CC} = 3.3V	12.6/12.4	ns

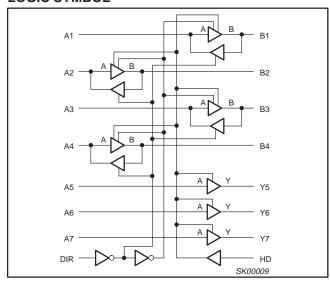
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DRAWING NUMBER
20-pin plastic SO	0°C to +70°C	7LVC1284 D	SOT163-1
20-pin plastic SSOP Type II	0°C to +70°C	74LVC1284 DB	SOT339-1
20-pin plastic TSSOP Type I	0°C to +70°C	74LVC1284 PW	SOT360-1

PIN CONFIGURATION



LOGIC SYMBOL



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PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1,2,3,4	A1 - A4	Data inputs/outputs
20,19,18,17	B1 - B4	IEEE 1284 Std. outputs/inputs
7,8,9	A5 - A7	Data inputs
14,13,12	Y5 - Y7	IEEE 1284 Std. outputs
10	DIR	Direction selection
11	HD	B/Y-side high drive enable/disable
5,6	GND	Ground (0V)
15,16	V _{CC}	Positive supply voltage

FUNCTION TABLE

	INPUTS		OUTPUTS	INPUTS/	OUTPUTS
DIR	HD	A5-7	Y5-7	A1-4	B1-4
L	L	L	L	A = B	Inputs
L	L	Н	Z	A = B	Inputs
L	Н	L	L	A = B	Inputs
L	Н	Н	Н	A = B	Inputs
Н	L	L	L	Inputs Low	Outputs Low
Н	L	Н	Z	Inputs High	Outputs Z
Н	Н	L	L	Inputs	B = A
Н	н н н		Н	Inputs	B = A

H = High Voltage

ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
	ESD Immunity, per Mil Std 883C method 3015		±2	kV
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	±20	mA
lok	DC output diode current	V _O < 0	±50	mA
V _{IN}	DC input voltage ³		-0.5 to +5.5	V
V _{OUT} B/Y _{DC}	DC output voltage on B/Y side ³		-0.5 to +5.5	V
V _{OUT} B/Y (tr)	Transient output voltage on B/Y side ⁴	40ns transient	−2 to +7	V
V _{OUT} A side	DC output voltage on A side		–0.5 to V _{CC} +0.5	V
I _O	DC output current	Outputs in High or Low state	±50	mA
T _{stg}	Storage temperature range		-60 to +150	°C
I _{CC} /I _{GND}	Continuous current through V _{CC} or GND		±200	mA

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- V_{OUT} B/Y (tr) guarantees only that this part will not be damaged by reflections in application so long as the voltage levels remain in the specified range.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
31MBOL	TANAMETER	MIN	MAX	ONIT
V _{CC}	DC supply voltage	3.0	3.6	V
VI	Input voltage	0	V _{CC}	V
V _{OUT}	B/Y output voltage	-0.5	5.5	V
V _{OUT}	A side output voltage	0	V _{CC}	V
I _{OH}	B/Y side output current High		-14	mA
I _{OL}	B/Y side output current Low		14	mA
T _{amb}	Operating free-air temperature range	0	+70	°C

L = Low Voltage

Z = High Impedance, Off-State

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DC ELECTRICAL CHARACTERISTICS

						LIMIT	S		
SYMBOL	PARAME	TER	TEST CONDITIONS	T _{an}	_{1b} = 25°0	;	T _{amb} = 0°C	to +70°C	UNIT
				MIN	TYP	MAX	MIN	MAX	1
	Llieb level	An	V_{CC} = Min to Max; I_{OH} = -50 μ A	V _{CC} -0.2	V _{CC}		V _{CC} -0.2		V
V _{OH}	High-level output voltage	All	$V_{CC} = 3.0V; I_{OH} = -4mA$	2.4			2.4		V
	, ,	Bn or Yn	V _{CC} = 3.0V; I _{OH} = 14mA	2.2	2.4		2.1		V
	Low-level	An	V_{CC} = Min to Max; I_{OL} = 50 μ A; V_I = V_{IL} or V_{IH}			0.2		0.2	V
V _{OL}	output voltage Bn or Yn High-level input voltage		$V_{CC} = 3.0V$; $I_{OL} = 4mA$; $V_I = V_{IL}$ or V_{IH}			0.4		0.4	V
			$V_{CC} = 3.0V$; $I_{OL} = -14mA$; $V_I = V_{IL}$ or V_{IH}			0.8		0.9	V
V _{IH}	High-level input voltage Low-level input voltage		V _{CC} = Min to Max			0.8		0.8	
V _{IL}	1 0		V _{CC} = Min to Max	2.0			2.0		
V _{HYS}	Input Hysteresis		$V_{CC} = 3.3V$		0.4		0.3		V
R _D	B/Y side Output Impedance	t	See Figure 2	38	45	53	35	55	Ω
II	Input leakage c (A5-A7 DIR, HD		V_{CC} = 3.6V; V_{O} = V_{CC} or GND; Not for I/O pins			±1.0		±5.0	μА
I _{IHZ} /I _{ILZ}	Input current for I/O pins	r common	$V_{CC} = 3.6V; V_I = 5.5V \text{ or GND}$		±0.1	±15			μА
l _{OFF}	B/Y Side Power leakage current		$V_{CC} = 0.0V; V_{O} = 0 \text{ to } 5.5V$			±10		±100	μА
l _{OZH}	3-State output High current Yn		$V_{CC} = 3.6V$; $V_O = V_{CC}$; $V_I = V_{IL}$ or V_{IH}			5		20	μА
I _{OZL}	3-State output Low current Yn		$V_{CC} = 3.6V$; $V_O = GND$; $V_I = V_{IL}$ or V_{IH}			-5		-20	μА
I _{IH} +I _{OZH}	current (A1 – A	4, Bn)	$V_{CC} = 3.6V; V_{I/O} = V_{CC}$			5		25	μΑ
I _{IL} +I _{OZL}	current (A1 – A	4, Bn)	$V_{CC} = 3.6V; V_{I/O} = GND$			- 5		-25	μΑ
Icc	Quiescent Supp Current	oly	$V_{CC} = 3.6V$; $I_O = 0$; $V_I = GND$ or V_{CC}		5	10		50	μΑ

AC CHARACTERISTICS

GND = 0V, $t_R = t_F = 3.0$ ns, $C_L = 50$ pF, $R_L = 500\Omega$

					LIMITS			
SYMBOL	PARAMETER	WAVEFORM	-	Γ _{amb} = 25°C V _{CC} = 3.3V	-	T _{amb} = 0 t V _{CC} = Min	o + 70°C n to Max	UNIT
			MIN	TYP	MAX	MIN	MAX	1
SR	B-Side Slew Rate	4	0.05	0.2	0.35	0.05	0.4	V/ns
t _{PLH} t _{PHL}	Propagation delay A toY or A to B	5	6.0 6.0	12.6 12.4	18.0 18.0	5.0 5.0	19.5 20.0	ns
t _{PLH} t _{PHL}	Propagation delay B to A	1	1.5 1.5	5.5 5.6	7.9 7.6	1.5 1.5	9.5 9.0	ns
t _{PZH} t _{PHZ}	Output enable/disable time to/from High level HD to Y or HD to B	2	4.0 2.0	12.0 6.5	16.0 9.1	4.0 2.0	20.0 11.0	ns
t _{PZL} t _{PLZ}	Output enable/disable time to/from Low level A to Y or A to B	2	5.0 1.5	12.7 5.0	16.3 7.1	5.0 1.5	20.0 9.0	ns
t _{PZH} t _{PZL}	Output enable time from DIR to B	2	8.0 8.0	12.3 12.7	18.0 18.0	4.0 4.0	20.0 20.0	ns
t _{PHZ} t _{PLZ}	Output disable time from DIR to B	2	5.0 6.0	8.9 9.1	12.5 12.0	2.0 2.0	14.5 14.0	ns
t _{PZH} t _{PZL}	Output enable time from DIR to A	2	3.5 4.0	6.9 8.6	13.0 14.0	3.0 3.0	14.5 16.0	ns
t _{PHZ} t _{PLZ}	Output disable from DIR to A	2	2.5 2.5	3.7 3.7	5.5 5.0	2.0 2.0	6.0 5.5	ns

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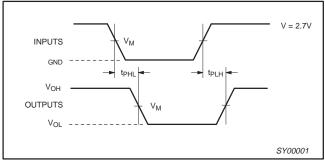
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AC WAVEFORMS

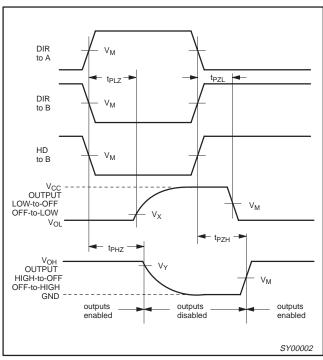
 $V_M = 1.5V$ $V_X = V_{OL} \pm 0.3V$

 $V_Y = V_{OH} - 0.3V$

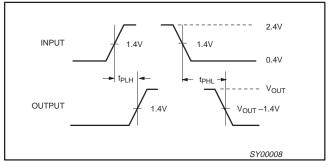
 V_{OL} and V_{OH} are the typical output voltage drops that occur with the output load. (V $_{CC}$ never goes below 3.0V).



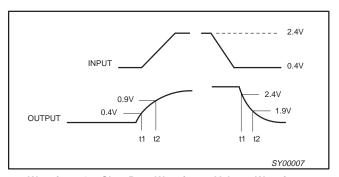
Waveform 1. Input Bn to output An propagation delays



Waveform 2. 3-State enable and disable times



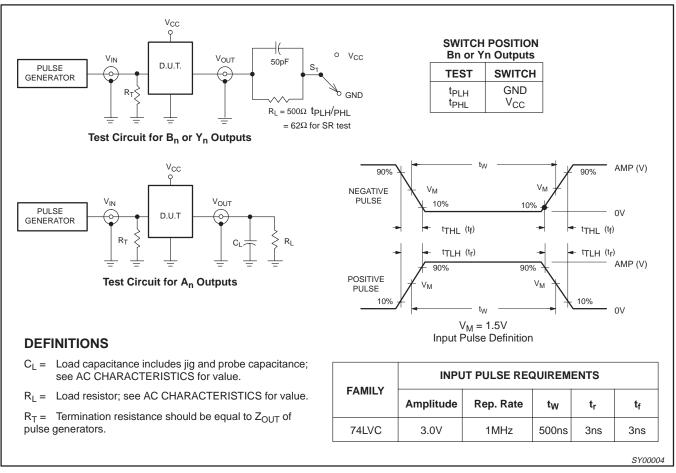
Waveform 3. Voltage Waveforms Propagation Delay Times (A To B) Measured at Output Pin



Waveform 4. Slew Rate Waveforms Voltage Waveforms (Input pulse rise and fall time are 3ns, 150ns < pulse width <10 μs , for both a Low to High and a High to Low transition.) Slew Rate measured between 0.4V and 0.9V - rising. Slew Rate measured between 2.4V and 1.9V - falling. Slew Rate measured at TP1.

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Waveform 5.

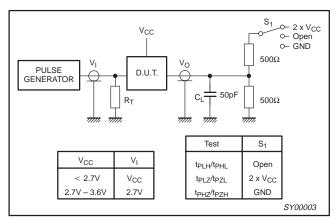


Figure 1. Load Circuitry for Bn to An Switching Times

TEST CIRCUIT

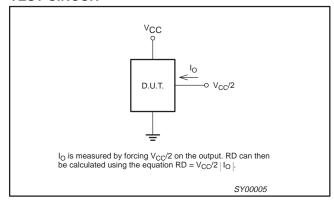


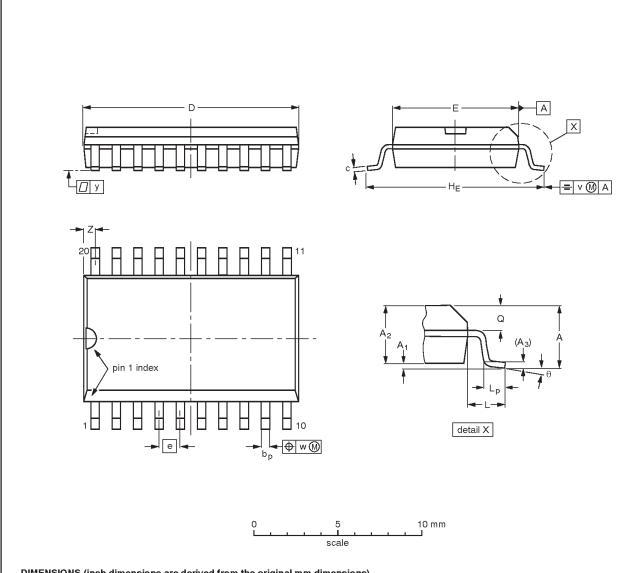
Figure 2. Output Impedance RD

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	O	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	o°

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC				92-11-17 95-01-24

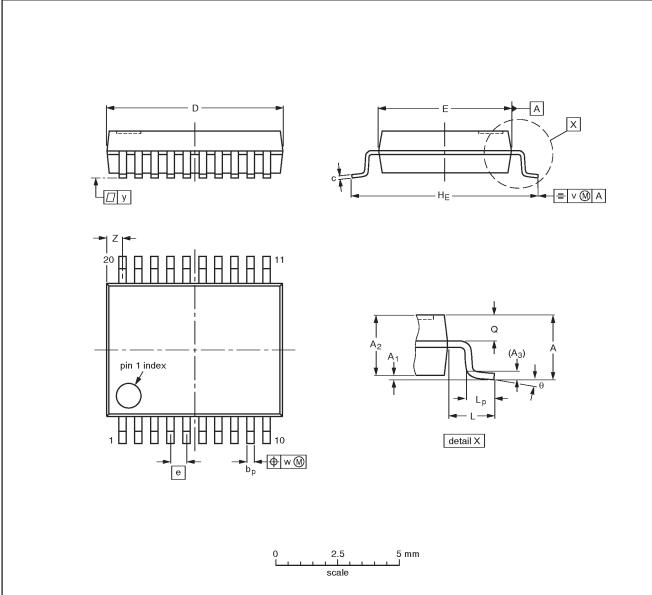
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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	А3	р _р	O	D ⁽¹⁾	E ⁽¹⁾	Ф	HE	٦	Lp	Ø	v	v	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

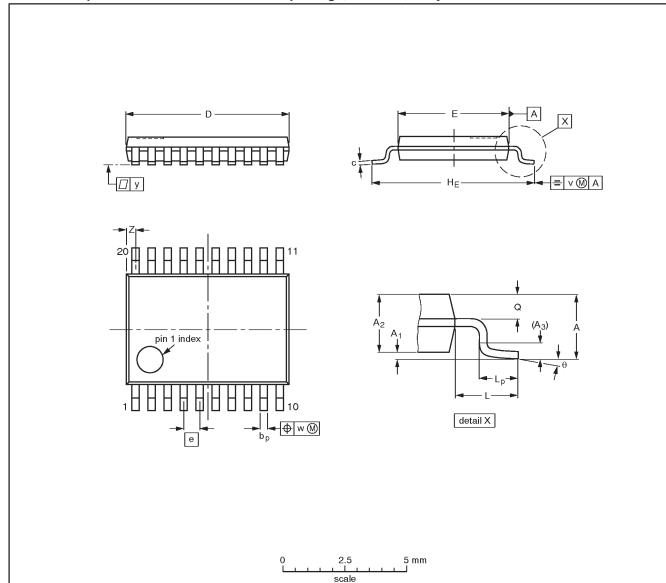
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT339-1		MO-150AE			-93-09-08 95-02-04	

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	рb	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT360-1		MO-153AC			-93-06-16 95-02-04	

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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